



# 3N65

**Power MOSFET**

## 3A, 650V N-CHANNEL POWER MOSFET

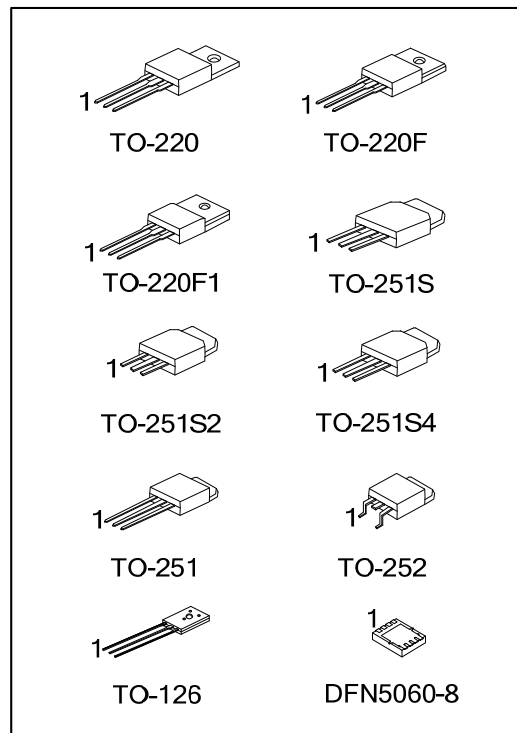
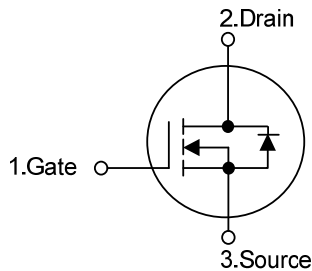
■ DESCRIPTION

The UTC **3N65** is a high voltage and high current power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications at power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

■ FEATURES

- \*  $R_{DS(ON)} < 3.8\Omega @ V_{GS} = 10V, I_D = 1.5A$
- \* Fast switching capability
- \* Avalanche energy specified
- \* Improved dv/dt capability, high ruggedness

■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
3N65L-TA3-T	3N65G-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
3N65L-TF1-T	3N65G-TF1-T	TO-220F1	G	D	S	-	-	-	-	-	Tube
3N65L-TF3-T	3N65G-TF3-T	TO-220F	G	D	S	-	-	-	-	-	Tube
3N65L-TM3-T	3N65G-TM3-T	TO-251	G	D	S	-	-	-	-	-	Tube
3N65L-TMS-T	3N65G-TMS-T	TO-251S	G	D	S	-	-	-	-	-	Tube
3N65L-TMS2-T	3N65G-TMS2-T	TO-251S2	G	D	S	-	-	-	-	-	Tube
3N65L-TMS4-T	3N65G-TMS4-T	TO-251S4	G	D	S	-	-	-	-	-	Tube
3N65L-TN3-R	3N65G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
3N65L-T60-K	3N65G-T60-K	TO-126	G	D	S	-	-	-	-	-	Bulk
3N65L-K08-5060-R	3N65G-K08-5060-R	DFN5060-8	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>3N65G-TA3-T</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Green Package</p>	<p>(1) R: Tape Reel, T: Tube, K: Bulk</p> <p>(2) TA3: TO-220, TF1: TO-220F1, TF3: TO-220F, TM3: TO-251, TN3: TO-252, TMS: TO-251S, T60: TO-126, K08-5060: DFN5060-8</p> <p>(3) G: Halogen Free and Lead Free, L: Lead Free</p>
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■ MARKING

Package		MARKING
TO-220 TO-220F TO-220F1 TO-251	TO-251S TO-251S2 TO-251S4 TO-252	<p>             UTC              3N65 □              □□□□□□ → Data Code              Lot Code ← □□□□□□              1           </p> <p>             L: Lead Free              G: Halogen Free           </p>
TO-126		<p>             UTC □□□□ → Data Code              3N65 □              1 → L: Lead Free              G: Halogen Free           </p>
DFN5060-8		<p>             UTC              3N65              • □□□□□□ → Date Code              Lot Code ← □□□□□□           </p>

■ ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DSS}$	650	V
Gate-Source Voltage	$V_{GSS}$	$\pm 30$	V
Avalanche Current (Note 2)	$I_{AR}$	3.0	A
Continuous Drain Current	$I_D$	3.0	A
Pulsed Drain Current (Note 2)	$I_{DM}$	12	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	200
	Repetitive (Note 2)	$E_{AR}$	7.5
Peak Diode Recovery dv/dt (Note 4)	dv/dt	4.5	V/ns
Power Dissipation	TO-220	$P_D$	75
	TO-220F/TO-220F1		34
	TO-251/TO-252/TO-251S TO-251S2/TO-251S4		50
	TO-126		17
	DFN5060-8		25
Junction Temperature	$T_J$	+150	$^\circ\text{C}$
Operating Temperature	$T_{OPR}$	-55 ~ +150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3.  $L = 64\text{mH}$ ,  $I_{AS} = 2.4\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 3.0\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient	$\theta_{JA}$	TO-220/TO-220F TO-220F1	62.5
		TO-251/TO-252/TO-251S TO-251S2/TO-251S4	110
		TO-126	132
		DFN5060-8	75 (Note)
Junction to Case	$\theta_{JC}$	TO-220	1.67
		TO-220F/TO-220F1	3.68
		TO-251/TO-252/TO-251S TO-251S2/TO-251S4	2.5
		TO-126	7.36
		DFN5060-8	5 (Note)

Note: The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

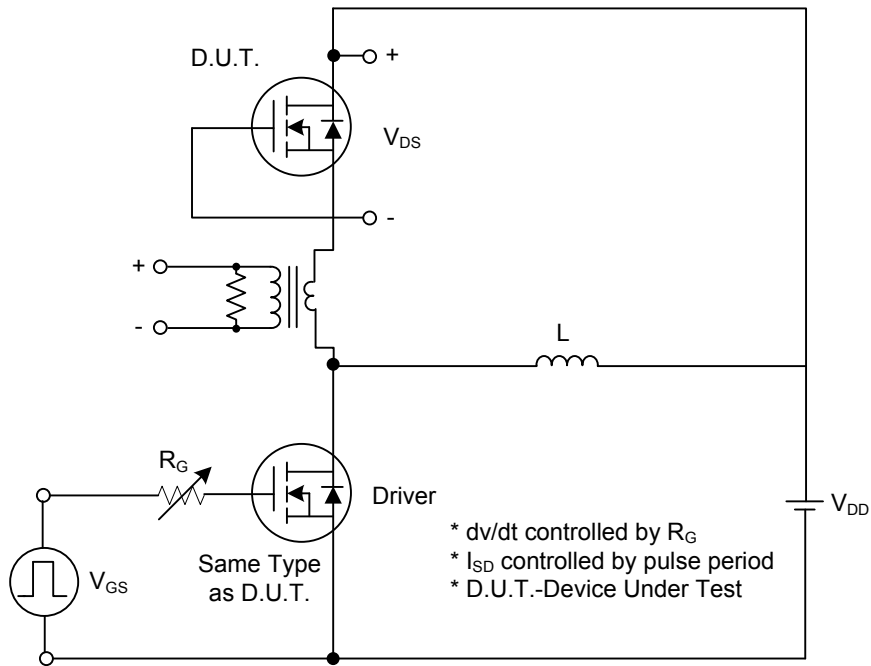
■ ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	650			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V			10	μA
Gate-Source Leakage Current	Forward	I <sub>GSS</sub>			100	nA
	Reverse				V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V	
Breakdown Voltage Temperature Coefficient	ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	I <sub>D</sub> =250μA, Referenced to 25°C		0.6		V/°C
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0		4.0	V
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.5A		2.8	3.8	Ω
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1MHz		430	500	pF
Output Capacitance	C <sub>OSS</sub>			50	65	pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			11	20	pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge	Q <sub>G</sub>	V <sub>DS</sub> = 50V, I <sub>D</sub> = 1.3A, V <sub>GS</sub> = 10 V (Note 1, 2)		51	70	nC
Gate-Source Charge	Q <sub>GS</sub>			13		nC
Gate-Drain Charge	Q <sub>GD</sub>			11		nC
Turn-On Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> = 30V, I <sub>D</sub> = 0.5A, R <sub>G</sub> = 25Ω (Note 1, 2)		32	45	ns
Turn-On Rise Time	t <sub>R</sub>			64	80	ns
Turn-Off Delay Time	t <sub>D(OFF)</sub>			115	140	ns
Turn-Off Fall Time	t <sub>F</sub>			60	75	ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Continuous Drain-Source Diode Forward Current	I <sub>S</sub>				3.0	A
Maximum Pulsed Drain-Source Diode Forward Current	I <sub>SM</sub>				12	A
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 3.0 A			1.4	V

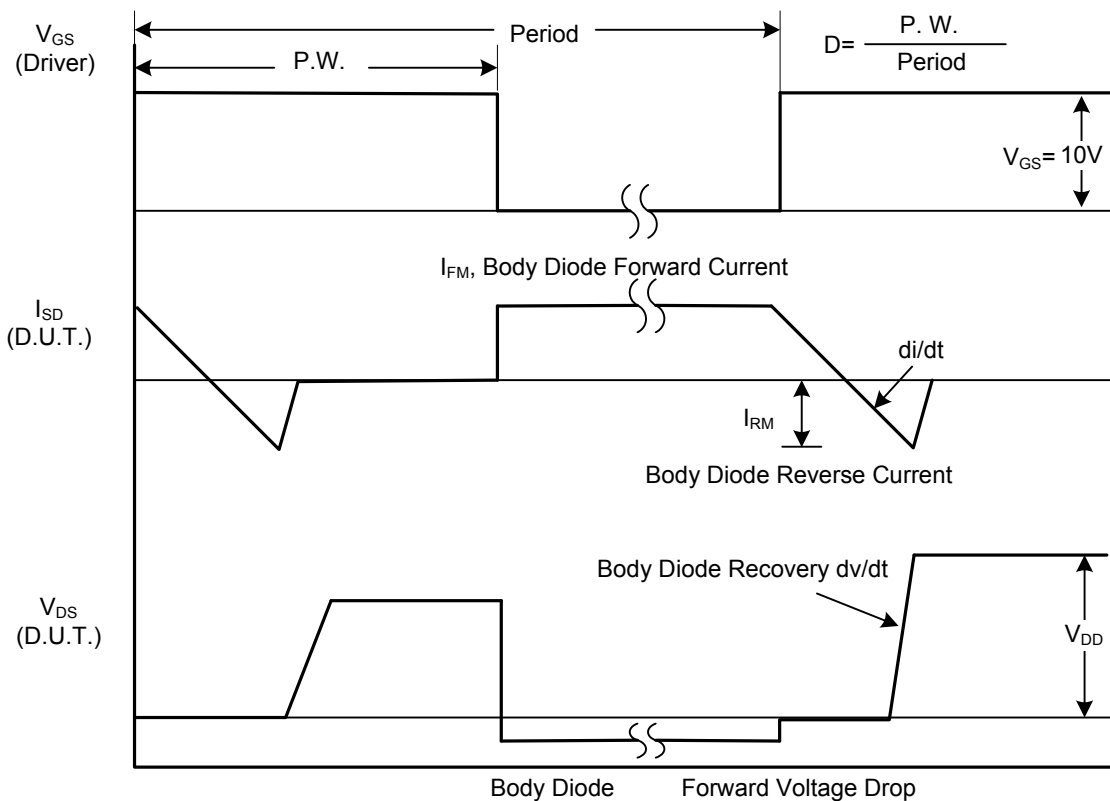
Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L = 64mH, I<sub>AS</sub> = 2.4A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25 Ω, Starting T<sub>J</sub> = 25°C

■ TEST CIRCUITS AND WAVEFORMS

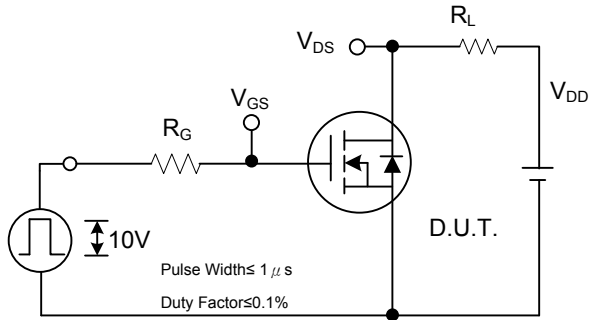


Peak Diode Recovery  $dv/dt$  Test Circuit

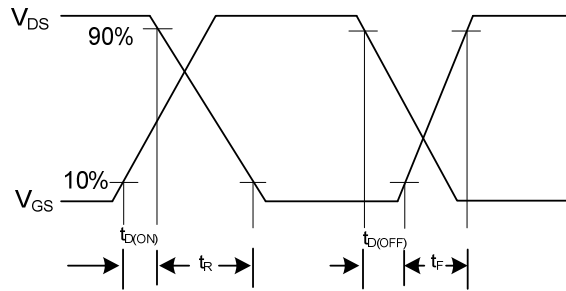


Peak Diode Recovery  $dv/dt$  Waveforms

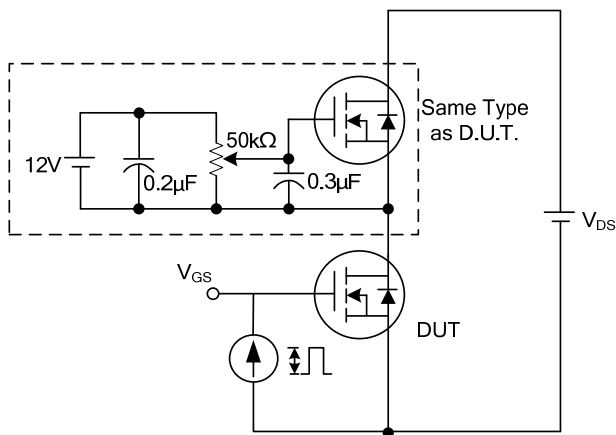
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



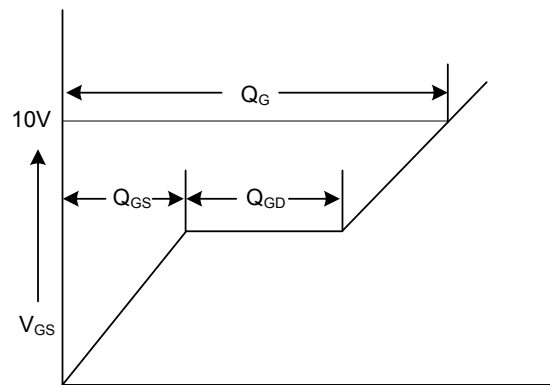
Switching Test Circuit



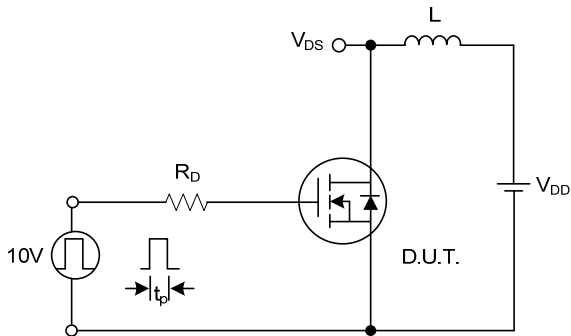
Switching Waveforms



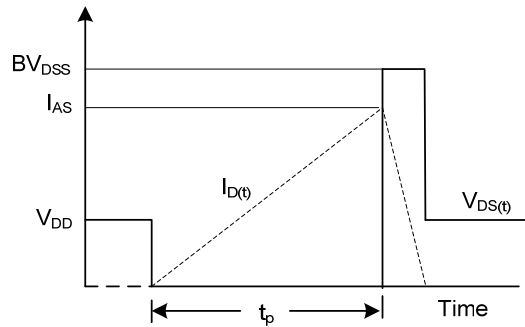
Gate Charge Test Circuit



Gate Charge Waveform



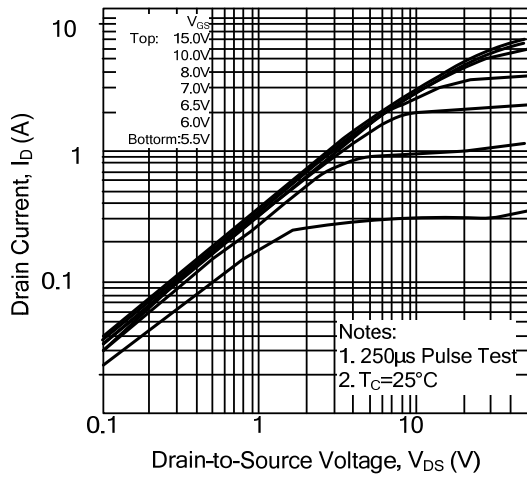
Unclamped Inductive Switching Test Circuit



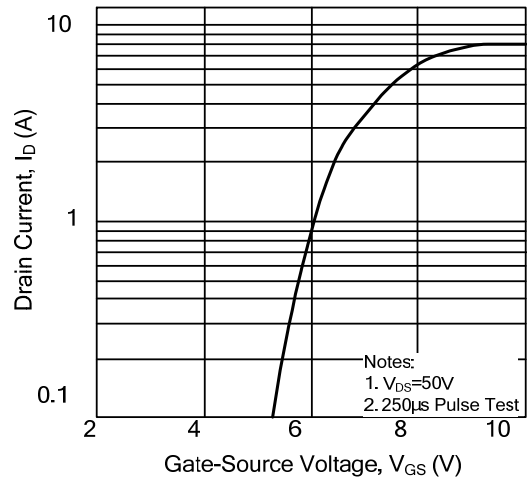
Unclamped Inductive Switching Waveforms

## TYPICAL CHARACTERISTICS

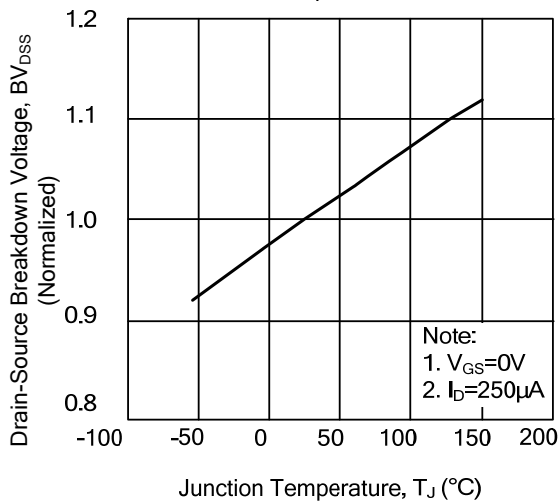
### On-State Characteristics



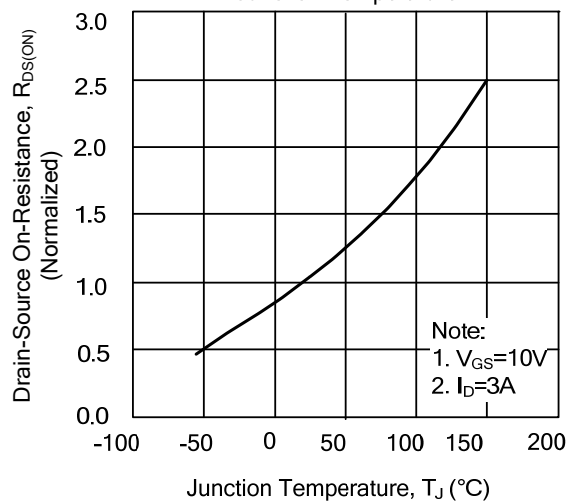
### Transfer Characteristics



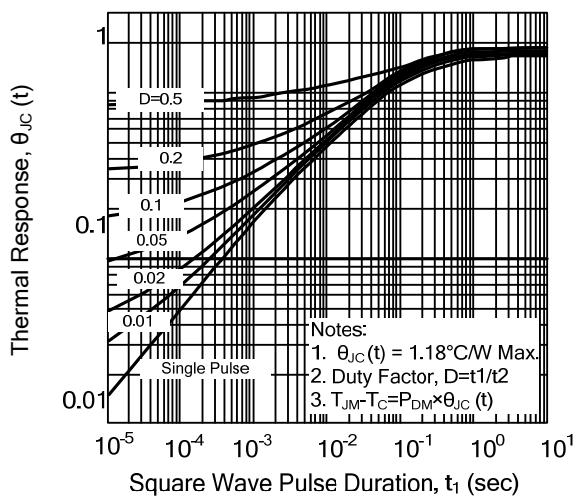
### Breakdown Voltage Variation vs. Junction Temperature



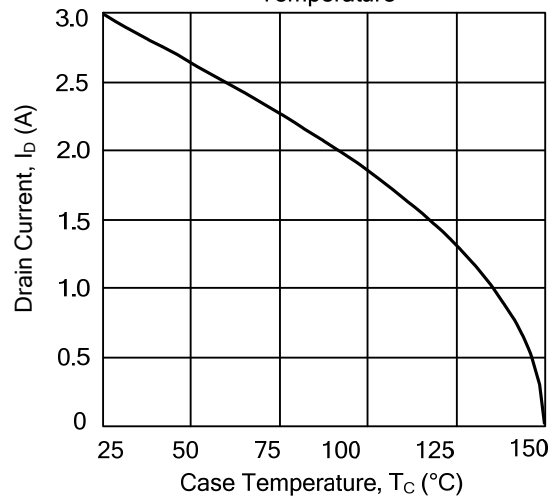
### On-Resistance Variation vs. Junction Temperature



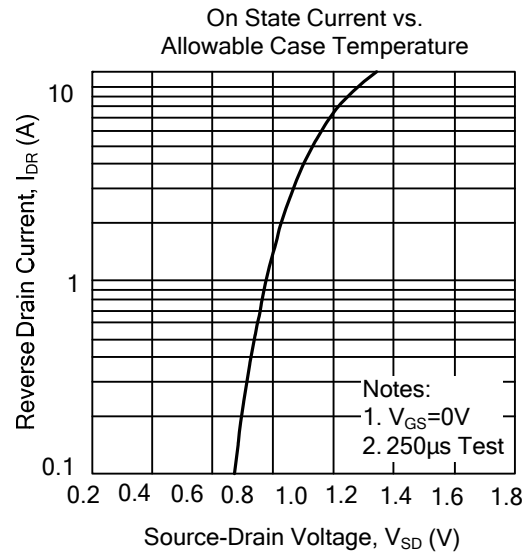
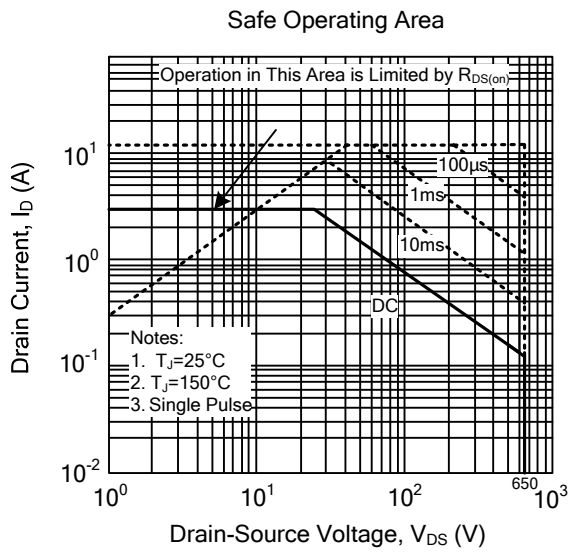
### Transient Thermal Response Curve



### Maximum Drain Current vs. Case Temperature



■ TYPICAL CHARACTERISTICS(Cont.)



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